



The Riverside Construction Company Harmon/Lounsbury Scholarship Fund Engineering Scholarship Application Guidelines for High School Students Application Deadline: April 2, 2021

The Riverside Construction Company, Harmon/Lounsbury Scholarship Fund provides college financial assistance to outstanding graduating seniors from Riverside who are pursuing a college education in engineering, particularly in the area of construction or civil engineering.

Recipients receive a scholarship award to an accredited public or private institution of higher learning. The scholarship awards are outright grant awards. No services will be required as a consequence of receiving the award. Scholarship awards are for tuition, books, education fees, and/or living expenses. The minimum scholarship award is \$1,000.

Scholarship criteria:

- Minimum 3.0 G.P.A.
- High school graduating senior planning to attend a college or university full time
- Course of study in engineering; priority given to construction or civil engineering
- Exhibit community and school involvement.
- Demonstrate financial need.
- Work experience is a consideration.

The application packet should include:

- 1) Completed application form
- 2) 2 letters of recommendation
- 3) Transcript
- 4) Essay

**Submit the application packet to:
Denisha Shackelford
Inland Empire Community Foundation
3700 Sixth St., Suite 200
Riverside, CA 92501**

For more information, contact Denisha Shackelford at (951) 241-7777 or at dshackelford@iegives.org





The Riverside Construction Company Harmon/Lounsbury Scholarship Fund

Engineering Scholarship Application for High School Students

Due: April 2, 2021

PLEASE PRINT OR TYPE:

I. APPLICANT INFORMATION:

Name: _____
 Last First Middle

Address: _____
 Number Street Apt. City State Zip Code

Home Phone Number: (____) _____ E-mail Address: _____
 Cell Phone Number: (____) _____ Birthdate: _____ Male ___ Female ___

II. FAMILY INFORMATION:

Name of Parent or Guardian: _____

Address: _____
 Number Street City State Zip Code

Occupation: _____ Telephone Number: (____) _____

III. TRANSCRIPT INFORMATION: A transcript must be attached to this application

Name of High School: _____
 GPA: (weighted) _____ ACT (if applicable) _____
 SAT Scores: Total _____ Critical Reading _____ Math _____ Writing _____

IV. MAJOR SCHOOL ACTIVITIES

List all school activities in which you have participated during the past 4 years (e.g. Student government, Clubs (legitimate ones recognized on campus), Performing Arts, Sports, etc.). Use additional page as needed.

Activity	Years of Participation	Special Awards, Honors	Activity	Years of Participation	Special Awards, Honors



V. COMMUNITY ACTIVITIES

List all community activities in which you have participated in without pay during the past 4 years (e.g. Scouts, Church involvement, Volunteer work, etc.). Use additional page as needed.

Activity	Years of Participation	Special Awards, Recognition	Activity	Years of Participation	Special Awards, Recognition

VI. WORK EXPERIENCE

Employer	Dates Employed	Job Description	Hrs Worked per Week	Hourly Rate of Pay

VII. COLLEGE/UNIVERSITY APPLIED TO AND MAJOR

The accredited colleges/ universities I have applied to and Major:

1. _____
2. _____
3. _____

VIII. ESSAY:

Write an essay (max. 500 words) on what you hope to achieve with a college degree in engineering, why you are interested in this field and the need for this scholarship. Include your educational and career goals.

IX. LETTERS OF RECOMMENDATION:

Please attach two (2) letters of recommendation from individuals in related fields of study (engineering, math, science) who are knowledgeable about your academic capabilities, skills, and talents.

X. APPLICANT CERTIFICATION

I certify that the information provided in this application is complete and accurate to the best of my knowledge. I understand that falsification of information may result in termination of any scholarship granted. I understand that the contents of this application will be shared with appropriate Review/ Approval Committees. If I am awarded a scholarship, information about me may be released for publicity purposes.

Printed Name: _____

Signature: _____ **Date** _____

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Inland Empire Community Foundation
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